

# STTA312B(-TR)

# TURBOSWITCH™ "A" . ULTRA-FAST HIGH VOLTAGE DIODE

#### MAIN PRODUCT CHARACTERISTICS

I <sub>F(AV)</sub>	3 A
Vrrm	1200 V
V <sub>F</sub> (max)	1.7 V
t <sub>rr</sub> (typ)	65 ns

#### FEATURES AND BENEFITS

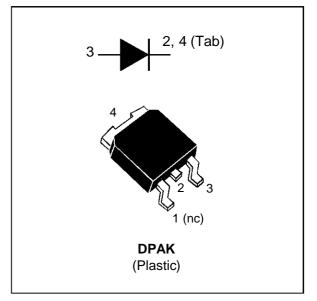
- SPECIFIC TO THE FOLLOWING OPERATIONS: SNUBBING OR CLAMPING, DEMAGNETIZA-TION AND RECTIFICATION
- ULTRA-FAST, VERY SOFT AND NOISE-FREE RECOVERY
- VERY LOW OVERALL POWER LOSSES AND PARTICULARY LOW FORWARD VOLTAGE
- DESIGNED FOR HIGH PULSED CURRENT OP-ERATIONS
- SURFACE MOUNT DEVICE
- TAPE AND REEL OPTION : -TR

#### DESCRIPTION

The TURBOSWITCH is a very high performance series of ultra-fast voltage power diodes from 600V to 1200V.

TURBOSWITCH 1200V drastically cuts losses in all high voltage operations which require extremely fast, soft and noise-free power diodes.

Due to their optimized switching performances they also highly decrease power losses in any associated switching IGBT or MOSFET in all "FreePRELIMINARY DATASHEET



wheel Mode" operations.

They are particularly suitable in Motor Control circuitries, or in primary of SMPS as snubber, clamping or demagnetizing diodes, and also in at the secondary of SMPS as high voltage rectifier diodes.

Packaged in DPAK Surface Mount enveloppe, these 1200V devices are particulary intended for use on triphase 400V industrial mains.

Symbol	Parameter	Value	Unit	
V <sub>RRM</sub>	Repetitive Peak Reverse Voltage	1200	V	
V <sub>RSM</sub>	Non Repetitive Surge Reverse Voltage	1200	V	
I <sub>F(RMS)</sub>	RMS Forward Current	8	А	
I <sub>FRM</sub>	Repetitive Peak Forward Current	tp =5 μs F = 1 KHz	110	A
T <sub>stg</sub>	Storage Temperature Range	- 65 to + 150	°C	
Tj	Max. Junction Temperature	125	°C	

ABSOLUTE MAXIMUM RATINGS

TM : TURBOSWITCH is a trademark from SGS-THOMSON Microelectronics.

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#### THERMAL AND POWER DATA

Symbol	Parameter	Conditions	Value	Unit	
R <sub>th (j-c)</sub>	Junction to Case Thermal Resistance		6.5	°C/W	
P <sub>1</sub>	Conduction Power Dissipation	$\begin{split} I_{F(AV)} &= 1.5 \text{A}, \delta = 0.5 \\ T_L &= 80^{\circ}\text{C} \end{split}$	6.7	W	
P <sub>max</sub>	Total Power Dissipation $P_{max} = P_1 + P_3$ (P <sub>3</sub> = 10% P <sub>1</sub> )	T <sub>L</sub> = 76°C	7.5	°C/W	

## STATIC ELECTRICAL CHARACTERISTICS

Symbol	<b>Tests Conditions</b>	Tests Conditions		Min.	Тур.	Max.	Unit
I <sub>R</sub> *	Reverse leakage	Tj = 25°C	$V_R = 0.8 \text{ X} V_{RRM}$		2	20	μA
	Current	Tj = 125°C			150	400	μA
V <sub>F</sub> **	Forward Voltage	Tj = 25°C	I <sub>F</sub> = 3 A		1.25	1.8	V
	drop	Tj = 125°C	I <sub>F</sub> = 3 A		1.15	1.7	

Pulse test : \* tp = 5 ms, duty cycle < 2 %

\*\* tp =  $380 \,\mu$ s, duty cycle < 2%

#### DYNAMIC ELECTRICAL CHARACTERISTICS

#### **TURN-OFF SWITCHING**

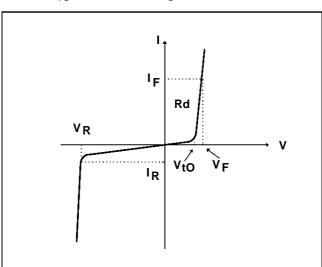
Symbol	Parameter	Test Conditions			Тур.	Max.	Unit
t <sub>rr</sub>		Tj = 25°C	I <sub>F</sub> =0.5A I <sub>R</sub> =1A I <sub>rr</sub> =0.25A I <sub>F</sub> =1A dI <sub>F</sub> /dt=A/μs V <sub>R</sub> =30V		65	115	ns
t <sub>fr</sub>	Maximum Reverse Recovery Current	Tj = 125℃	I <sub>F</sub> =2A V <sub>R</sub> =400V dI <sub>F</sub> /dt = -16A/μs dI <sub>F</sub> /dt = -50A/μs			3.6	A
S factor	Softness Factor	Tj = 125℃	V <sub>R</sub> =400V I <sub>F</sub> =2A dI <sub>F</sub> /dt = -50A/µs		TBD		/

## **TURN-ON SWITCHING**

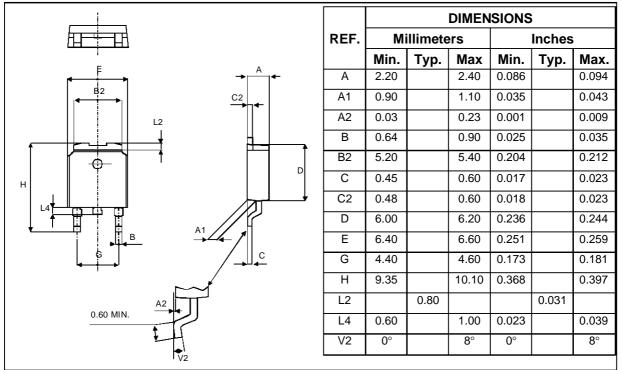
Symbol	Parameter	Test Conditions			Тур.	Max.	Unit
t <sub>rr</sub>	Forward Recovery Time	Tj = 25°C	$I_F=2A$ $dI_F/dt = 16A/\mu s$ Measured at 1.1 x $V_{Fmax}$			900	ns
Vpf	Peak Forward	Tj = 25°C	l⊧=2A dl⊧/dt = 16A/μs			30	V
	Voltage	T j= 25℃	l⊧=5A dl⊧/dt = 50A/μs			30	



 $\label{eq:result} \begin{array}{ll} \mbox{Fig. 1}: \mbox{STATIC CHARACTERISTICS}: \\ V_{TO} = 1.15V \\ \end{array} \\ \begin{array}{ll} R_D = 185 m \Omega \end{array}$ 



PACKAGE MECHANICAL DATA DPAK



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